APPLICATION DATA SHEET

Electronic Version v14

Stylesheet Version v14.0

Title of Invention

EXTERNAL VERIFICATION OF PACKAGE PROCESSED LINEWIDTHS AND SPACINGS IN SEMICONDUCTOR PACKAGES

Application Type: regular, utility

Attorney Docket Number: FIS920030167US1

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as our attorney(s) or agent(s) to prosecute the application identified above, and to transact all	
business in the United States Patent and Trademark Office connected therewith.	
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